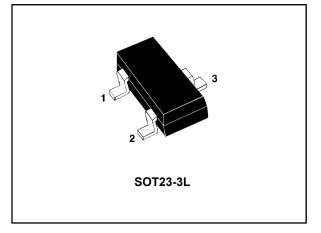


# **ESDALY**

## Automotive dual Transil<sup>™</sup> array for ESD protection

Datasheet - production data



### Features

AEC-Q101 qualified



- **Dual unidirectional Transil functions**
- Low leakage current:  $I_R$  max. < 20  $\mu$ A at  $V_{BR}$
- 300 W peak pulse power (8/20 µs)

### **Benefits**

- High ESD protection level: up to 25 kV
- High integration
- Suitable for high density boards
- AEC-Q101 qualified

### Complies with the following standards

- ISO 10605: C = 330 pF, R = 330 Ω
  - 30 kV (air discharge)
  - 30 kV (contact discharge)
- ISO 7637-3 fast transient
  - Pulse a:  $V_s = -150 V$
  - Pulse b:  $V_s$  = +100 V
- ISO 7637-3 slow transient
  - Positive pulse:  $V_S$  = +85 V
  - Negative pulse : Vs = -85 V

## **Applications**

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Entertainment •
- Signal communications
  - Connectivity
  - Comfort and convenience

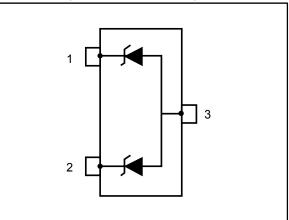
### Description

This device is a diode array designed to protect 1 line or 2 lines against ESD transients.

The device is ideal for applications where both reduced line capacitance and board space saving are required

It can also be used as bidirectional suppressor by connecting only pin 1 and 2.

#### Figure 1: Functional diagram



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This is information on a product in full production.

## 1 Characteristics

Table 1: Absolute maximum ratings (T <sub>amb</sub> = 25 °C)					
Symbol	F	Value	Unit		
		ISO 10605 (C = 330 pF, R = 330 Ω):			
	Peak pulse voltage <sup>(1)</sup>	Contact discharge	30		
V		Air discharge	30	kV	
V <sub>pp</sub>		ISO 10605 (C = 150 pF, R = 330 Ω):		ĸv	
		Contact discharge	30		
		Air discharge	30		
P <sub>pp</sub>	Peak pulse power (8/20 µs)	300	W		
	Peak pulse current (8/20 µs)	ESDA5V3LY ESDA6V1LY			
I <sub>pp</sub>		ESDA14V2LY	14	Α	
		ESDA25LY	7		
		ESDA37LY	6.3		
Tj	Operating junction temperature	-40 to 150	°C		
T <sub>stg</sub>	Storage junction temperature	-65 to 150	°C		
TL	Maximum temperature for solo	260	°C		

#### Table 1: Absolute maximum ratings (T<sub>amb</sub> = 25 °C)

#### Notes:

<sup>(1)</sup>For a surge greater than the maximum values, the diode will fail in short-circuit.

$\begin{array}{l} \text{Symbol} \\ \text{V}_{\text{BR}} & = \\ \text{V}_{\text{CL}} & = \\ \text{I}_{\text{RM}} & = \\ \text{I}_{\text{R}} & = \\ \text{I}_{\text{PP}} & = \\ \text{I}_{\text{R}} & = \\ \text{V}_{\text{F}} & = \\ \text{C} & = \\ \text{R}_{\text{d}} & = \\ \text{\alpha}\text{T} & = \end{array}$	Parameter Breakdown voltage Clamping voltage Stand-off voltage Leakage current Forward current Peak pulse current Breakdown current Forward voltage drop Capacitance Dynamic impedance Voltage temperature	VBR Vd ♥ VRM Skope = 1/Rd	IF VF VF IRM IPP
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#### Figure 2: Electrical characteristics (definitions)



#### Characteristics

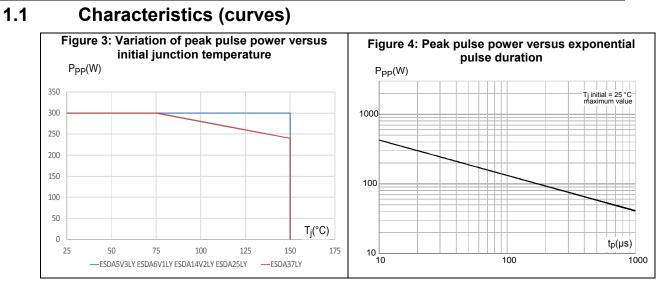
Table 2: Electrical characteristics (T <sub>amb</sub> = 25 °C)										
	V <sub>BR</sub> at I <sub>R</sub>		IRM at VRM		Rd <sup>(1)</sup>	αT <sup>(2)</sup>	Cline	V <sub>F</sub> a	it I⊧	
Order code	Min.	Max.		Max.		Тур.	Max.	Typ. at 0 V bias	Max.	
	v	v	mA	μA	v	mΩ	10 <sup>-4</sup> /°C	pF	v	mA
ESDA5V3LY	5.3	5.9	1	2	3	280	5	220	1.25	200
ESDA6V1LY	6.1	7.2	1	20	5.25	350	6	140	1.25	200
ESDA14V2LY	14.2	15.8	1	5	12	650	11	90	1.25	200
ESDA25LY	25	30	1	1	24	1000	11	50	1.2	10
ESDA37LY	37	43.3	1	1	36	2400	11	48	0.9	10

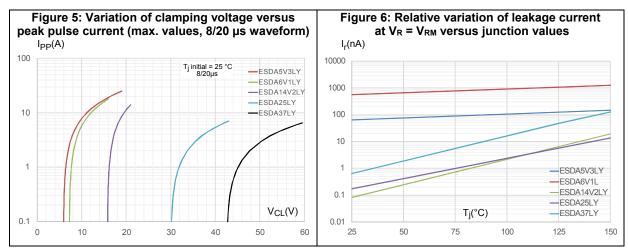
#### Notes:

 $^{(1)}$ Square pulse Ipp = 15 A, tp = 2.5  $\mu s$ 

 $^{(2)}\!\Delta$  V\_BR =  $\alpha T$  x (Tamb -25 °C) x V\_BR (25 °C)



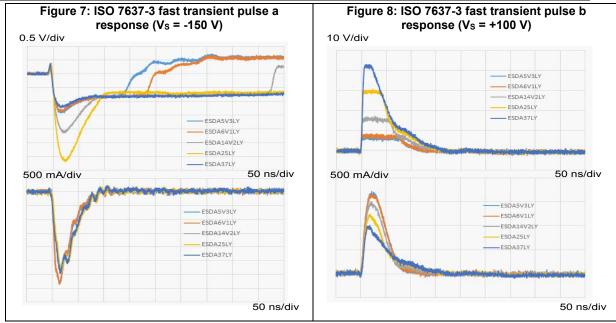


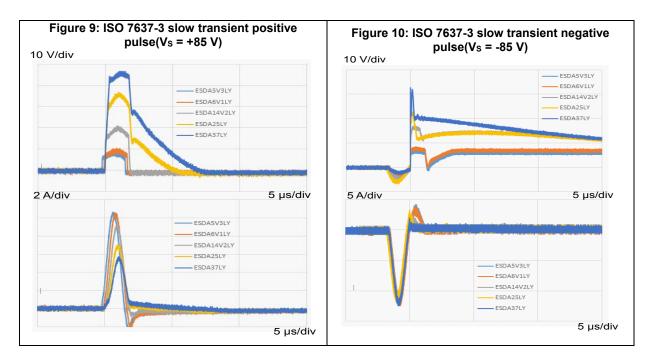






#### Characteristics





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## 2 Application and design guidelines

Refer to STMicroelectronics application note:

• AN2689: Protection of automotive electronics from electrical hazards, guidelines for design and component selection.

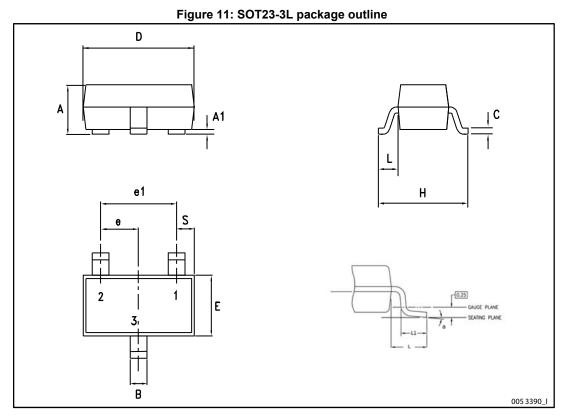


## **3** Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

- Epoxy meets UL 94,V0
- Lead-free package

## 3.1 SOT23-3L mechanical data



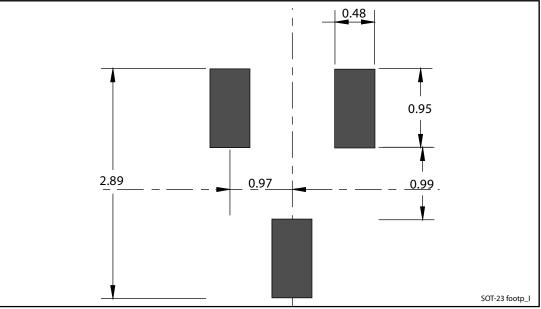


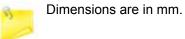
#### Package information

#### ESDALY

Table 3: SOT23-3L mechanical data					
Dim					
Dim.	Min.	Тур.	Max.		
A	0.89		1.40		
A1	0		0.10		
В	0.30		0.51		
С	0.085		0.18		
D	2.75		3.04		
е	0.85		1.05		
e1	1.70		2.10		
E	1.20		1.75		
Н	2.10		3.00		
L		0.60			
S	0.35		0.65		
L1	0.25		0.55		
а	0°		8°		

#### Figure 12: SOT23-3L recommended footprint





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#### ESDALY

## 4 **Recommendation on PCB assembly**

### 4.1 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size 20-45 μm.

### 4.2 Placement

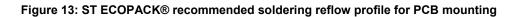
- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering
- 3. Standard tolerance of  $\pm 0.05$  mm is recommended.
- 4. 3.5 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

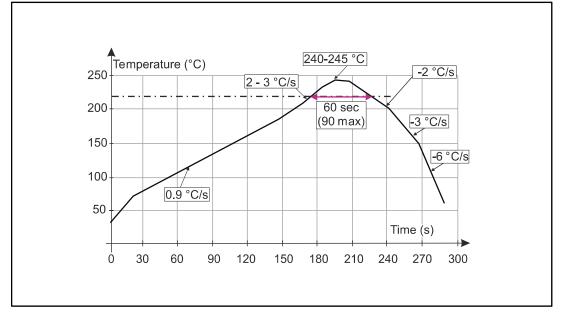
### 4.3 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. A symmetrical layout is recommended, to avoid any tilt phenomena caused by asymmetrical solder paste due to solder flow away.



### 4.4 Reflow profile







Minimize air convection currents in the reflow oven to avoid component movement.



## 5 Ordering information

Figure 14: Ordering information scheme

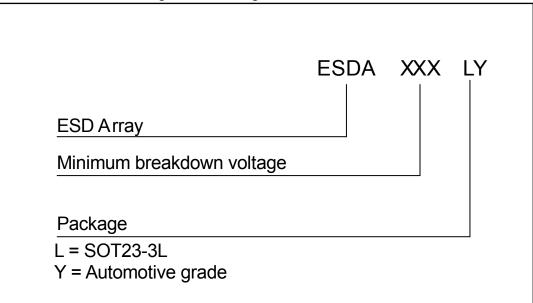


Table 4: Ordering information

-			<u> </u>		
Order code	Marking <sup>(1)</sup>	Package	Weight	Base qty.	Delivery mode
ESDA5V3LY	EL5Y				
ESDA6V1LY	EL6Y	SOT23-3L	0.7		
ESDA14V2LY	EL1Y		8.7 mg	3000	Tape and reel
ESDA25LY	EL2Y				
ESDA37LY	EL3Y		9.8 mg		

#### Notes:

 $^{(1)}$ The marking can be rotated by multiples of 90° to differentiate assembly location.

## 6 Revision history

#### Table 5: Document revision history

Date	Revision	Changes
16-Feb-2012	1	Initial version. This document merges and updates the content of the datasheet ESDA25LY Revision 1, 01-Feb-2010.
20-Jul-2017	2	Added ESDA37LY package information.



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